HD30761
SOLID STATE HIGH POWER AMPLIFIER

FEATURES

Designed for EMI/RFI, lab, CW/Pulse and all communication applications
Small form factor, rack mounted system
Class A/AB Linear design
High Power Advanced technology devices
Instantaneous ultra-wide bandwidth
Built-in protection circuits, with extensive monitoring
Local LCD & remote flexible interfaces
High efficiency, with unprecedented reliability and ruggedness



ELECTRICAL SPECIFICATIONS : 25°C, 50Ω

Parameter	Specification	Notes
Operating Frequency Range	1 - 1000 MHz	
Power Output @ Psat	30 Watt Min	CW or Pulse
Power Output @ P1dB	25 Watt Min	
Power Gain	45 dB Min	0dBm or less for rated Pout
Power Gain Flatness	3 dB p-p Max (±1.5dB)	Constant input power
Gain Adjustment Range	20 dB Min	Local or remote capable
Input / Output Return Loss	-10 dB Max	
2-Tone Intermodulation (IMD)	-30 dBc Typ	35dBm/Tone, Δ = 1MHz
Harmonics	-20 dBc Typ	At rated output power
Spurious	-60 dBc Max	Non-harmonic
Operating Voltage	100 - 240 VAC	47 - 63Hz
Power Consumption	600 Watt Max	At rated output
Input Power Protection	+10 dBm Max[1]	
Load VSWR Protection	4 : 1: Max[2]	Foldback @ preset limit
Sample Port Coupling (optional)	-50 dB	N-Female

1 Units with optional digital monitor and control, for basic units <10 Sec without damage
2 Units with optional digital monitor and control, for basic units <1 minute at rated Pout

ENVIRONMENTAL CHARACTERISTICS

Parameter	Specification	Notes
Operating Ambient Temperature	0 to +50 °C	
Storage Temperature	-40 to +85 °C	
Relative Humidity	up to 95 %	Non-condensing
Altitude	3000 meters	
Shock & Vibration	Normal transport[3]	

3 MIL Spec available for quotation

MECHANICAL SPECIFICATIONS

Parameter	Specification	Notes
Dimensions W x H x D (No display with DMC)	430 x 88 x 560 mm	2U, excluding handles
Dimensions W x H x D (with Option DMC)	430 x 133.3 x 560 mm	3U, excluding handles
Weight	(2U/12 kg.) (3U/15kg.)	
RF Conn. In / Out / Sample	N-Female	Front or rear panel
Interface Connector	9-Pin D-Sub	Rear panel
AC Power	IEC 60320-C14	Or equivalent
Cooling	Built in Fan Cooling	Variable speed
OPTIONAL: Digital Monitor & Control (DMC) FWD, REV, VSWR, GAIN, ALC, V & I, TEMP, Optional Safety Interlock (INT)	Ethernet RJ-45 TCP/IP, RS422/485, USB Open=STBY/Short=RFON	 BNC-F rear panel

338 Jericho Tpk, Unit 387 Syosset, NY 11791 Phone: 631-588-3877
www.rfamplifiers.com sales@hdcom.com www.rfcomp.com
Specifications subject to change without notice.
Specifications and drawings may vary with selected options.

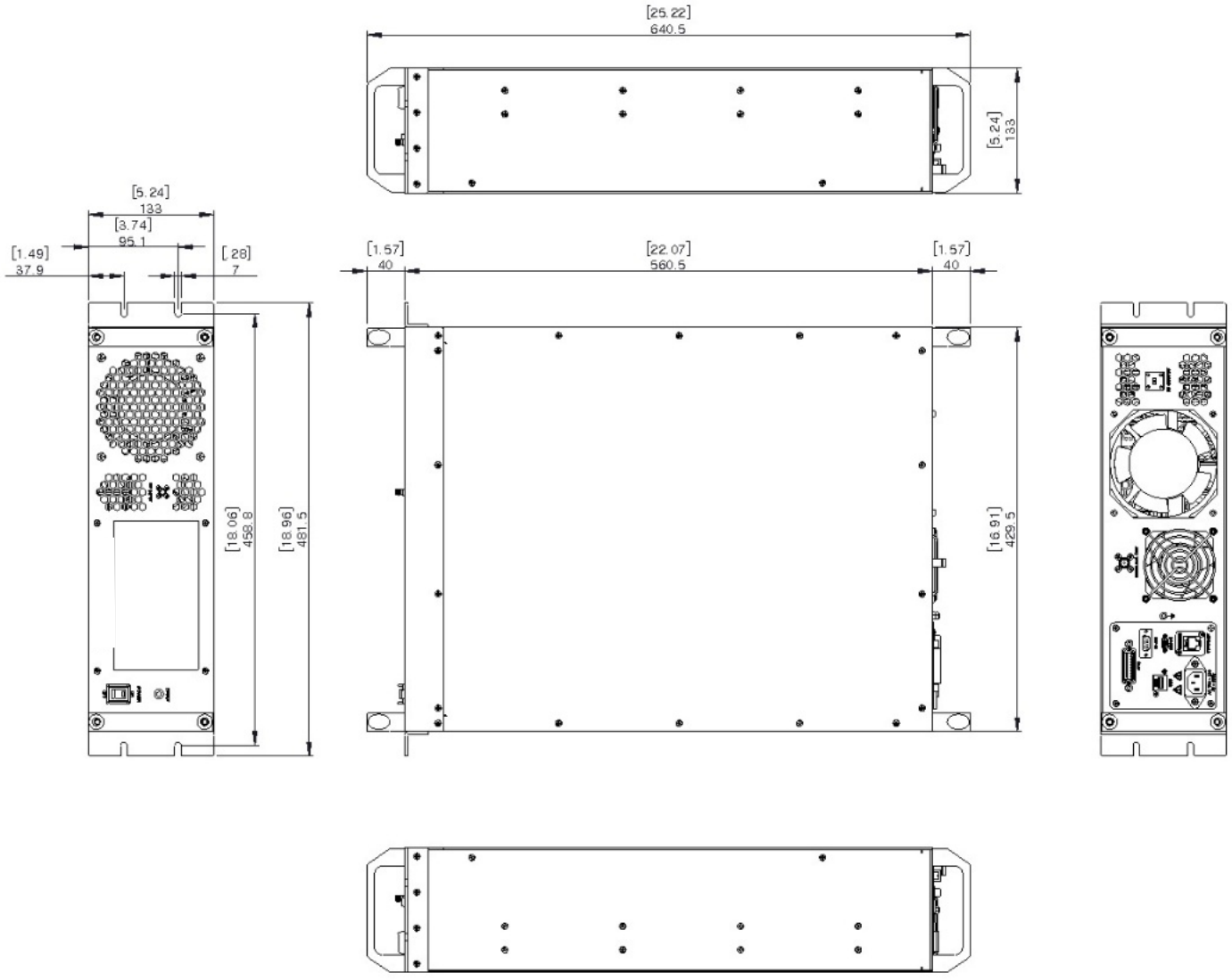
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AVAILABLE SPECIAL OPTIONS

Parameter	Specification	Notes
Option FRS: Forward RF Sample	-40dB, Type N-Female	Front or rear panel
Option RRS: Reflected RF Sample	-40dB, Type N-Female	Front or rear panel
Option GPIB: GPIB remote control	GPIB IEEE-488 Remote capability	
Included CPM: Calibrated Power Monitoring (With purchase of Option DMC)	Offset correction entry for +/- 0.2dB accuracy	11-points standard[4]

4 Consult with factory if additional points would be required.

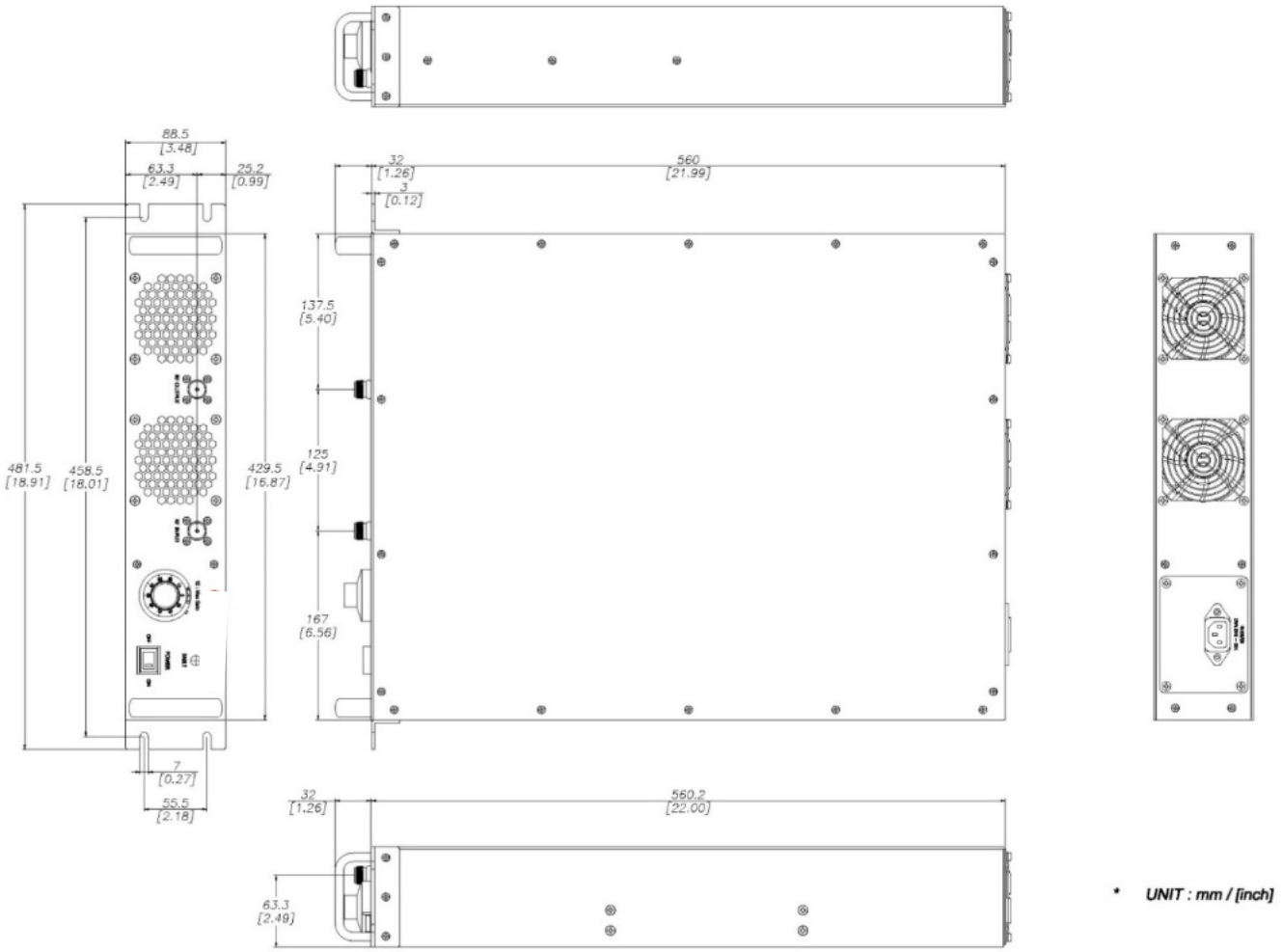
OUTLINE DRAWING
SHOWN WITH LCD DIGITAL CONTROLLER



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OUTLINE DRAWING
BASIC MODEL, NO DISPLAY WITH DMC OPTION



* UNIT : mm / [inch]

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